

Engineering/Process Change Notice

ECN/PCN No.: 4149

For Manufacturer					
Product Description: PLASTIC SMD MEMS OSCILLATOR	Abracon Part Numb EM	per / Part Series: RC13	 □ Documentation only □ ECN ⊠ EOL 	⊠ Series □ Part Number	
Affected Revision:	New Revision: E	OL	Application:	□ Safety ⊠ Non-Safety	
Prior to Change: Active https://abracon.com/datasheets/Ecliptek/EMRC13.pdf					
After Change: EOL					
Cause/Reason for Change: Discontinuation of manufacturing capabilit	ty.				
	Char	ige Plan			
Effective Date: 2/7/2022	Additional Remarks: N/A				
Change Declaration: N/A					
Issued Date: 2/7/2022	Issued By: Brooke Cushman Product Engineer		Issued Department: Engineering		
Approval: Thomas Culhane Engineering Director	Approval: Reuben Quintanilla Quality Director		Approval: Ying Huang Purchasing Director		
	For Abrad	on EOL only	1		
Last Time Buy (if applicable): 5/7/2022	Alternate Part Numb		per / Part Series: 7 (frequency=100-220MHz), reater than 220MHz or less than 100MHz)		
Additional Approval:	Additional Approva	:	Additional Approval:		
	Customer Appr	oval (If Applicable)			
Qualification Status:					
Customer Part Number:		Customer Project:			
Company Name:	Company Representative:		Representative Signature	:	
Customer Remarks:					

Form #7020 | Rev. G | Effective: 02/22/2021 |

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EMRC13 Series



REGULATORY COMPLIANCE Lead Free EU RoHS China RoHS REACH 2011/65 + Course Course Course Course

1	2011/65 + 2015/863	O	SVHC
COMPLIANT	COMPLIANT	COMPLIANT	COMPLIANT

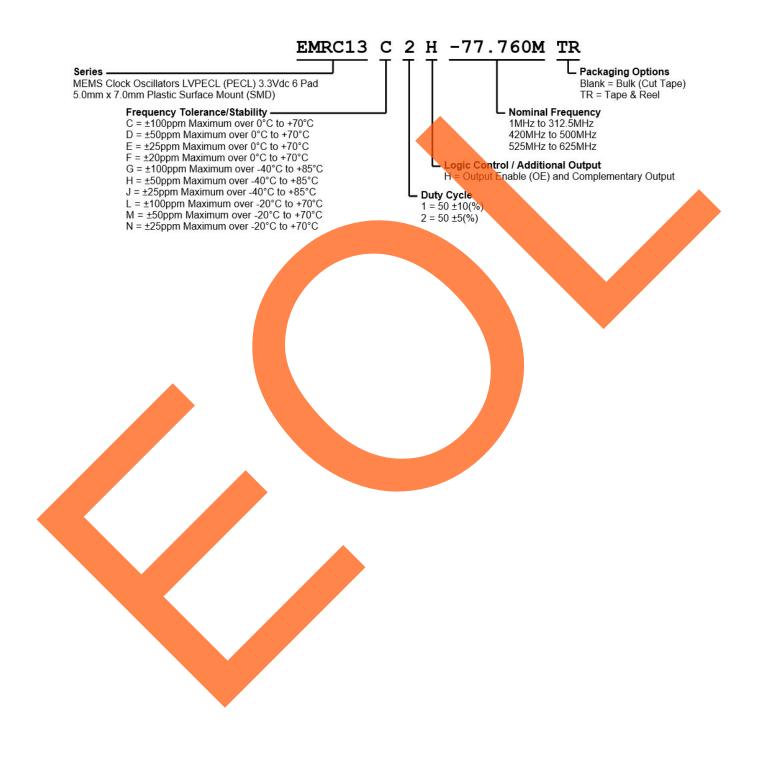
ITEM DESCRIPTION

MEMS Clock Oscillators LVPECL (PECL) 3.3Vdc 6 Pad 5.0mm x 7.0mm Plastic Surface Mount (SMD)

ELECTRICAL SPECIFICATIONS		
Nominal Frequency	1MHz to 625MHz	
Frequency Tolerance/Stability	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, 1st Year Aging at 25°C, Reflow, Shock, and Vibration ±100ppm Maximum over 0°C to +70°C ±50ppm Maximum over 0°C to +70°C ±25ppm Maximum over 0°C to +70°C ±20ppm Maximum over 0°C to +70°C ±100ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±25ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C	
Aging at 25°C	±1ppm First Year Maximum	
Supply Voltage	+3.3Vdc ±10%	
Input Current	Excluding Lo <mark>ad Term</mark> ination Current 60mA Typical, 70mA Maximum	
Output Voltage Logic High (V _{он})	Vdd -1.10Vdc <mark>Minimu</mark> m, 2.40Vdc Typical, Vdd -0.70Vdc Maxim <mark>um</mark>	
Output Voltage Logic Low (VoL)	Vdd -1.90Vdc Minimum, 1.60Vdc Typical, Vdd -1.50Vdc Maxim <mark>um</mark>	
Rise/Fall Time	Measured over 20% to 80% of waveform 300pSec Typical, 500pSec Maximum	
Duty Cycle	Measured at 50% of waveform 50 ±10(%) 50 ±5(%) (Not available with Duty Cycle of 50 ±5(%) over Nominal Frequency range of 312.500001MHz to 524.999999MHz)	
Output Swing (VOpp)	600mVdc Minimum, 800mVdc Typical, 1000mVdc Maximum	
Load Drive Capability	50 Ohms into Vcc-2.0Vdc	
Output Logic Type	LVPECL	
Logic Control / Additional Output	Output Enable (OE) and Complementary Output	
Output Control Input Voltage	Vih of 70% of Vdd Minimum of No Connect to Enable Output and Complementary Output, Vil of 30% of Vdd Maximum to Disable Output and Complementary Output (High Impedance)	
Output Enable Current	35mA Maximum (OE) Without Load	
RMS Phase Jitter	Fj = 12kHz to 20MHz; Random 0.5pSec Typical, 1pSec Maximum	
Period Jitter (Deterministic)	0.2pSec Typical	
Period Jitter (Random)	1.0pSec Typical	
Period Jitter (RMS)	1.4pSec Typical, 1.7pSec Maximum	
Period Jitter (pk-pk)	15pSec Typical, 20pSec Maximum	
Start Up Time	10mSec Maximum	
Storage Temperature Range	-55°C to +125°C	

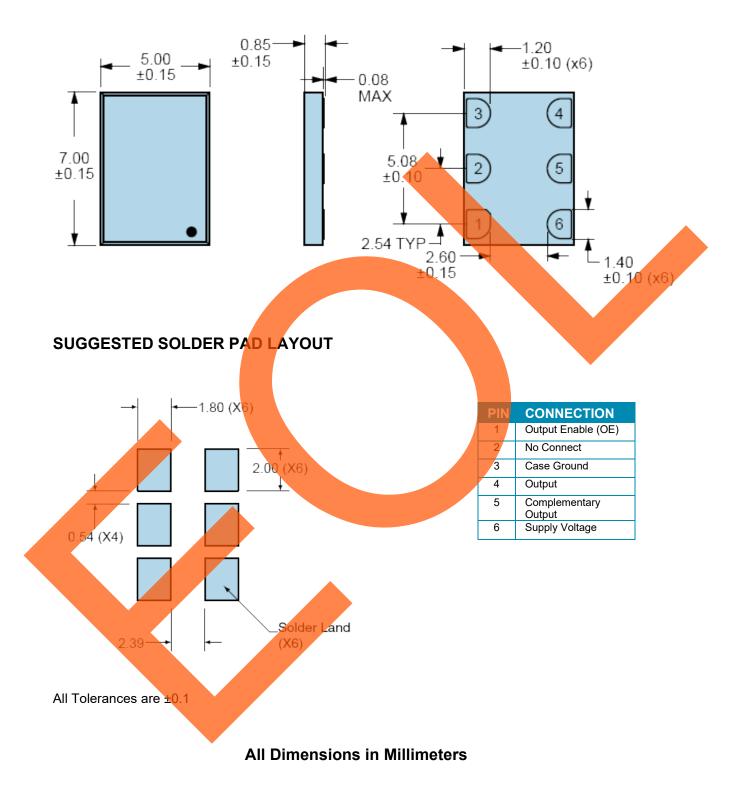


PART NUMBERING GUIDE





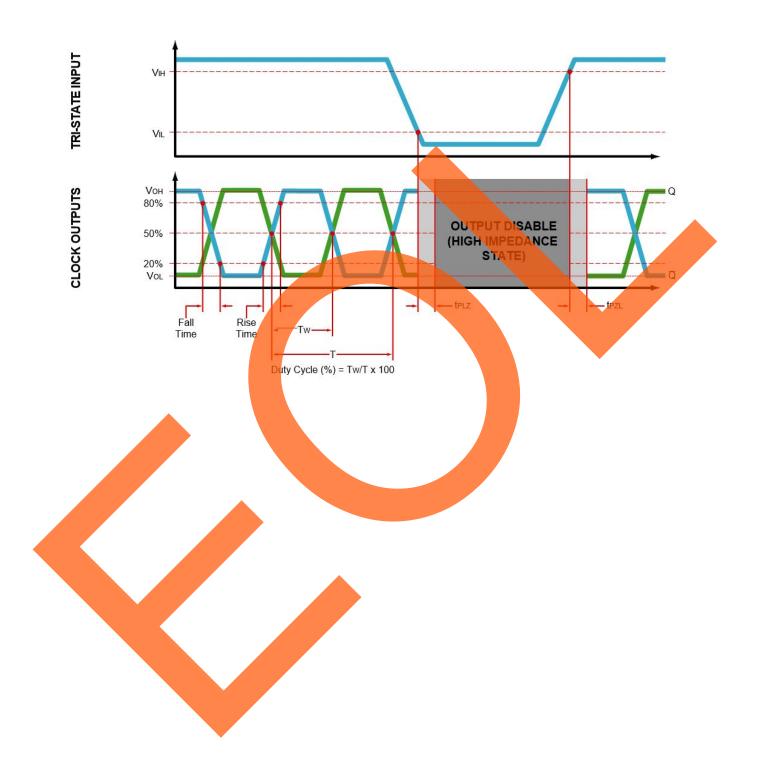
MECHANICAL DIMENSIONS



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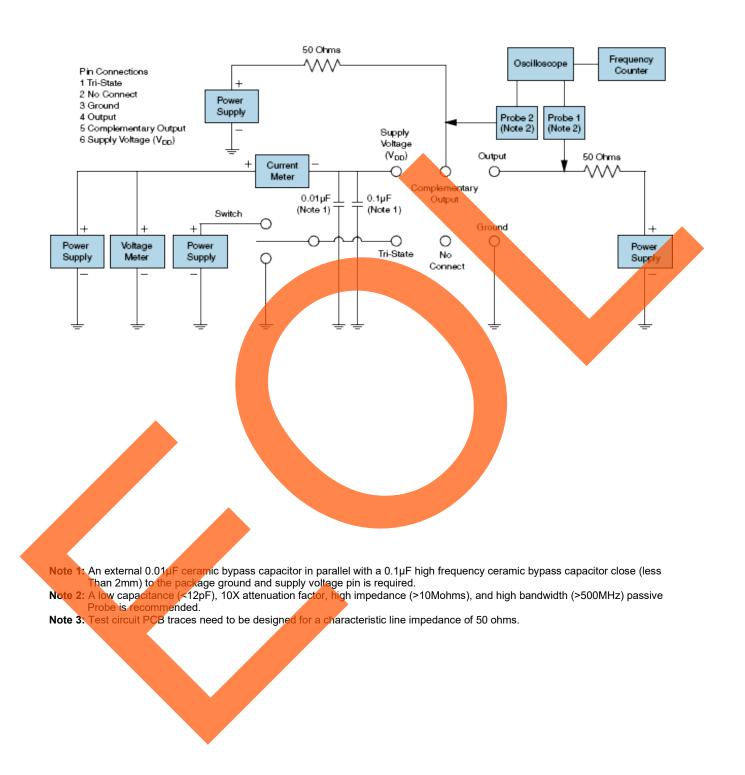


OUTPUT WAVEFORM & TIMING DIAGRAM





TEST CIRCUIT FOR TRI-STATE AND COMPLEMENTARY OUTPUT



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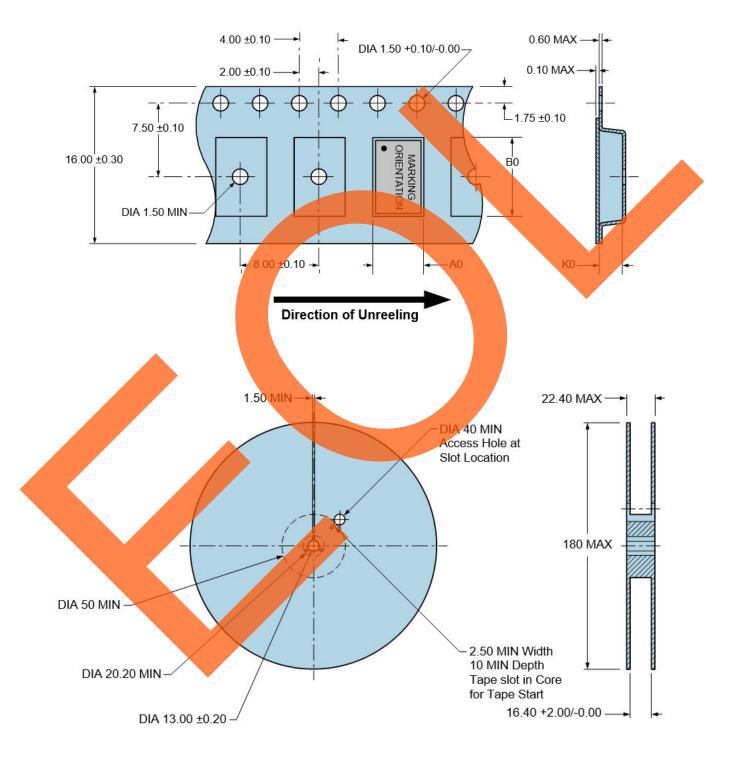


TAPE & REEL DIMENSIONS

Quantity per Reel: 1,000 Units

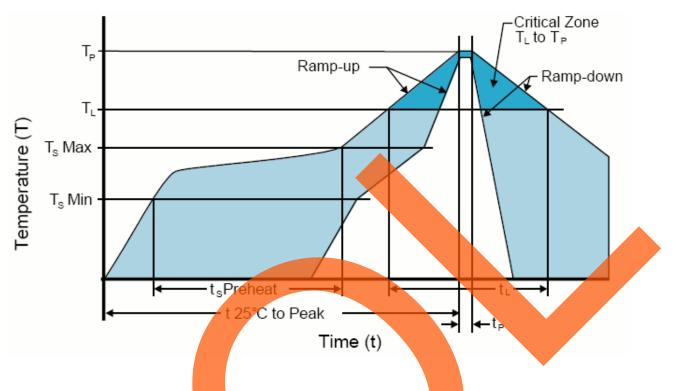
All Dimensions in Millimeters

Compliant to EIA-481





RECOMMENDED SOLDER REFLOW METHOD



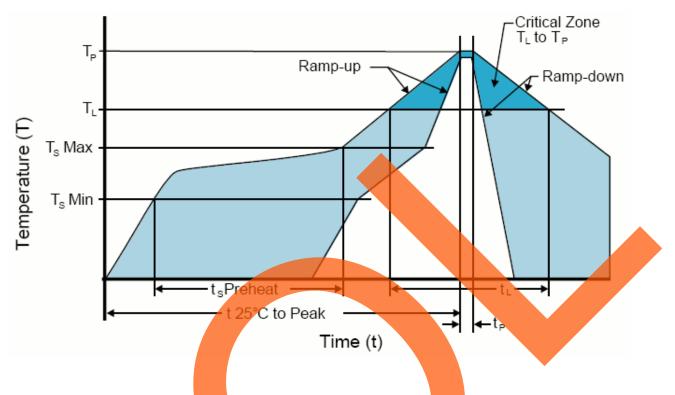
HIGH TEMPERATURE INFRARED/CONVECTION		
T _s MAX to T _L (Ramp-up Rate)	3°C/Second Maximum	
Preheat		
- Temperature Minimum (Ts MIN)	150°C	
- Temperature Typical (T _s TYP)	175°C	
- Temperature Maximum(T _s MAX)	200°C 60 - 180 Seconds	
- Time (t _s MIN)	ou 180 Seconds	
Ramp-up Rate (T _L to T _P)	3°C/Second Maximum	
Time Maintained Above:		
· · · · · · · · · · · · · · · · · · ·	217°C	
- Time (t _L)	60 - 150 Seconds	
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum	
Target Peak Temperature(T _P Target)	250°C +0/-5°C	
Time within 5°C of actual peak (t _p)	20 - 4 <mark>0 Seconds</mark>	
Ramp-down Rate	6°C/Second Maximum	
Time 25°C to Peak Temperature (t)	8 Minutes Maximum	
Moisture Sensitivity Level	Level 1	
Additional Notes	Temperatures shown are applied to body of device.	

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION		
T _s MAX to T _L (Ramp-up Rate)	5°C/Second Maximum	
Preheat		
- Temperature Minimum (Ts MIN)	N/A	
- Temperature Typical (T _s TYP)	150°C	
- Temperature Maximum(T _s MAX)		
- Time (t _s MIN)	60 - 120 Seconds	
Ramp-up Rate (T _L to T _P)	5°C/Second Maximum	
Time Maintained Above:		
- Temperature (T _L)	150°C	
- Time (t∟)	200 Seconds Maximum	
Peak Temperature (T _P)	240°C Maximum	
Target Peak Temperature(T _P Target)	240°C Maximum 2 Times/230°C Maximum 1Time	
Time within 5°C of actual peak (t _p)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time	
Ramp-down Rate	5°C/Second Maximum	
Time 25°C to Peak Temperature (t)	N/A	
Moisture Sensitivity Level	Level 1	
Additional Notes	Temperatures shown are applied to body of device.	

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)